WHAT IS CLAIMED IS:

1	1.	A ballistic magnetoresistive sensor, comprising:
2	a first	pinned layer;
3		free layer;
4	a nick	tel nano-contact layer disposed between the pinned layer and the free layer;
5	and	
6	a firs	t and second lead layer disposed proximate to the pinned layer and free layer
7	respectively	for providing a sense current that flows perpendicular to the planes of the
8	layers.	
1	2.	The ballistic magnetoresistive sensor of claim 1 further comprising layers
2	of tantalum	disposed between the pinned layer and between the first lead and the free
3	layer and the	e second lead.
		and the first pipped
1	3.	The ballistic magnetoresistive sensor of claim 1, wherein the first pinned
2	layer, first f	ree layer, nickel nano-contact layer and first and second lead layers form a
3	nano-contac	ct region.

The ballistic magnetoresistive sensor of claim 1 further comprising outside 1 4. structures disposed on opposite sides of the nano-contact region, the outside structures 2 comprising a second and third pinned layer, a second and third free layer, a first and 3 second insulation layer disposed between the second pinned layer and the second free 4 layer and between the third pinned layer and the third free layer, and outside lead layers 5 disposed proximate to the second and third pinned layers and the second and third free 6 7 layer. The ballistic magnetoresistive sensor of claim 4, wherein the pinned layers 5. 1 comprise a layer of nickel and a layer of cobalt iron (CoFe). 2 The ballistic magnetoresistive sensor of claim 4, wherein the free layers 6. 1 comprise a layer of nickel iron (NiFe). 2 The ballistic magnetoresistive sensor of claim 1 further comprising layers 7. 1 of tantalum disposed between the second pinned layer and one of the outside lead layers,

comprises a layer of nickel and a layer of cobalt iron (CoFe).

between the third pinned layer and one of the outside lead layers, between the second free

layer and one of the outside lead layers, and between the third pinned layer and one of the

The ballistic magnetoresistive sensor of claim 1, wherein the pinned layer

outside lead layers.

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1	9. T	he ballistic magnetoresistive sensor of claim 1, wherein the free layer	
2	comprises a layer of nickel iron (NiFe).		
1	10. A	A magnetic storage device, comprising:	
2	at least o	one magnetic storage medium;	
3	a motor for moving the at least one magnetic storage medium;		
4	a ballistic magnetoresistive sensor for reading data on the at least one magnetic		
5	storage medium, and		
6	an actua	ator assembly, coupled to the ballistic magnetoresistive sensor, for moving	
7	the ballistic magnetoresistive sensor relative to the at least one magnetic storage medium,		
8	the ballistic magnetoresistive sensor further comprising:		
9		a first pinned layer;	
10		a first free layer;	
11		a nickel nano-contact layer disposed between the pinned layer and the free	
12	layer; and		
13		a first and second lead layer disposed proximate to the pinned layer and	
14	free layer respectively for providing a sense current that flows perpendicular to the planes		
15	of the layers.		
		*	
1	11.	The magnetic storage device of claim 10 further comprising layers of	
2	tantalum disp	oosed between the pinned layer and the first lead and between the free layer	
3	and the second lead.		

The magnetic storage device of claim 10, wherein the first pinned layer, 12. 1 first free layer, nickel nano-contact layer and first and second lead layers form a nano-2 contact region. 3 The magnetic storage device of claim 10 further comprising outside 13. 1 structures disposed on opposite sides of the nano-contact region, the outside structures 2 comprising a second and third pinned layer, a second and third free layer, a first and 3 second insulation layer disposed between the second pinned layer and the second free 4 layer and between the third pinned layer and the third free layer, and outside lead layers 5 disposed proximate to the second and third pinned layers and the second and third free 6 layer. 7 The magnetic storage device of claim 13, wherein the pinned layers 14. 1 comprise a layer of nickel and a layer of cobalt iron (CoFe). 2 The magnetic storage device of claim 13, wherein the free layers comprise 15. 1 a layer of nickel iron (NiFe). 2 The magnetic storage device of claim 10 further comprising layers of 16. 1 tantalum disposed between the second pinned layer and one of the outside lead layers, 2 between the third pinned layer and one of the outside lead layers, between the second free 3 layer and one of the outside lead layers, and between the third pinned layer and one of the 4

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outside lead layers.

The magnetic storage device of claim 10, wherein the pinned layer 17. 1 comprises a layer of nickel and a layer of cobalt iron (CoFe). 2 The magnetic storage device of claim 10, wherein the free layer comprises 18. 1 a layer of nickel iron (NiFe). 2 A method for forming a ballistic magnetoresistive sensor, comprising: 19. 1 forming a first free layer; 2 a nickel nano-contact layer disposed between the pinned layer and the free layer; 3 forming a first pinned layer; and 4 forming a first and second lead layer disposed proximate to the pinned layer and 5 free layer respectively for providing a sense current that flows perpendicular to the planes 6 of the layers. 7 The method of claim 19 further comprising forming layers of tantalum 20. 1 between the pinned layer and the first lead and between the free layer and the second 2 3 lead. The method of claim 19, wherein the forming the first pinned layer, first 21. 1 free layer, nickel nano-contact layer and first and second lead layers further comprises 2 forming a nano-contact region. 3

l	22. The method of claim 19 further comprising:
2	forming outside structures disposed on opposite sides of the nano-contact region,
3	the forming the outside structures further comprising forming a second and third pinned
4	layer, forming a second and third free layer, forming a first and second insulation layer
5	disposed between the second pinned layer and the second free layer and between the third
6	pinned layer and the third free layer; and
7	forming outside lead layers disposed proximate to the second and third pinned
8	layers and the second and third free layer.
1	23. The method of claim 22, wherein the forming the pinned layers further
2	comprise forming a layer of nickel and a layer of cobalt iron (CoFe).
1	24. The method of claim 22, wherein the forming the free layers further
2	comprise forming a layer of nickel iron (NiFe).
1	25. The method of claim 19 further comprising forming layers of tantalum
2	between the second pinned layer and one of the outside lead layers, between the third
3	pinned layer and one of the outside lead layers, between the second free layer and one of
4	the outside lead layers, and between the third pinned layer and one of the outside lead
5	layers.
1	26. The method of claim 19, wherein the forming the pinned layer comprises
2	forming a layer of nickel and a layer of cobalt iron (CoFe).

l	27. The method of claim 19, wherein the forming the free layer comprises	
2	forming a layer of nickel iron (NiFe).	
1	28. A ballistic magnetoresistive sensor, comprising:	
2	means for providing a pinned layer;	
3	means for providing a free layer;	
4	means for providing a nickel nano-contact layer disposed between the means for	
5	providing a pinned layer and the means for providing a free layer; and	
6	means for providing a first and second lead layer disposed proximate to the means	
7	for providing the pinned layer and free layer respectively, the means for providing a first	
8	and second lead layer providing a sense current that flows perpendicular to the planes of	
9	the layers.	

1	29. A magnetic storage device, comprising:
2	means for recording magnetic data thereon;
3	means for moving the means for recording magnetic data;
4	means for reading data on the means for recording magnetic data; and
5	means, coupled to the means for reading, for moving the means for reading
6	relative to the means for storing data, the means for reading further comprising:
7	means for providing a pinned layer;
8	means for providing a free layer;
9	means for providing a nickel nano-contact layer disposed between the
10	means for providing a pinned layer and the means for providing a free layer; and
11	means for providing a first and second lead layer disposed proximate to
12	the means for providing the pinned layer and free layer respectively, the means for
13	providing a first and second lead layer providing a sense current that flows perpendicular
14	to the planes of the layers.